







USB-A, USBR-A, USB-AM SERIES

STANDARD & RUGGED USB 2.0

SPECIFICATIONS For complete specifications and recommended PCB layouts see www.samtec.com?USB-A or www.samtec.com?USBR-A

Insulator Material: High Temperature Thermoplastic Contact Material:

Phosphor Bronze
Shell Material: Copper Alloy
Plating: Gold on Contacts,

Plating: Gold on Contacts, Nickel on Shell, Tin on Tails Operating Temp Range: -50°C to +85°C

Current Rating: 1 A per contact Voltage Rating: 30 VAC Contact Resistance:

Contact Resistance: 30 mΩ max Cycles:

1500 (maximum number of cycles tested)

Packaging:

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Packaged and shipped in Bulk Packaging Trays; Trays suitable for automation are available upon request.

RoHS Compliant: Yes Lead-Free Solderable: -SM1=Yes

-TH, -VU & -VT=Yes (Wave Solder only) TID Numbers:

USB-A-D-X-X-TH (60001199) USB-A-S-X-X-TH (60001180) USB-A-S-X-X-SM1 (60001152

USB-A-S-X-X-SM1 (60001152) USB-A-S-X-VT (60001153)

SHELL **PLATING** COLOR **TERMINATION** TYPE **TYPE** -S ·B -TH = Single Gold Flash on Mating Area, = Black =Through-hole **USB** Tin on Tails = Standard Connector -D_W -SM1 -S = Double = White = Offset Surface **USBR** = 30µ" (0,76µm) Gold on Mating Area, -TH option Mount = Increased -0only) **Retention Connector** Tin on Tails -VU Orange (Complies with Class 1, (USBŘ = Upright, DIV II minimum withdrawal Through-Hole only) requirement of 15N.) –VT $\supset \square$ = Vertical, □∘ Through-Hole 0 00 0 \Box 13,72) (10.72) 422 -D (Requires -TH) _VII SAMTEC High retention

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?USB-AM

Insulator Material:
High Temperature
Thermoplastic
Contact Material:
Phosphor Bronze
Shell Material: Copper Alloy
Plating: Gold on Contacts,
Nickel on Shell. Tin on Tails

Nickel on Shell, Tin on Tails
Operating Temp Range:
-50°C to +85°C
Current Rating: 1 A per contact
Voltage Rating: 30 VAC
Contact Resistance: 30 mΩ max
Cycles: 1500 (maximum

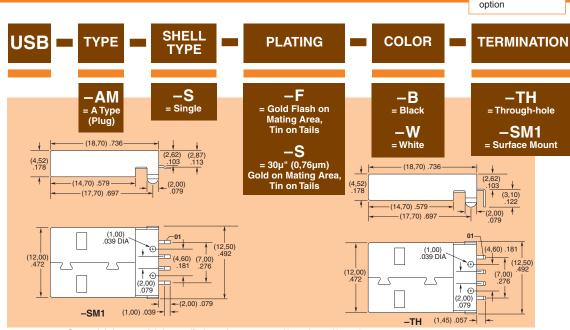
Cycles: 1500 (maximum number of cycles tested)
Packaging:

Packaged and shipped in Bulk Packaging Trays; Trays suitable for automation are available upon request.

upon request.
RoHS Compliant: Yes
Lead-Free Solderable:

-SM1=Yes -TH=Yes (Wave Solder only)

TID Number: USB-AM-S-X-X-SM (60001154)



Due to technical progress, all designs, specifications and components are subject to change without notice.

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